Baader Investment Conference

Munich, 25 September 2013

Dr. Reinhard Ploss

CEO

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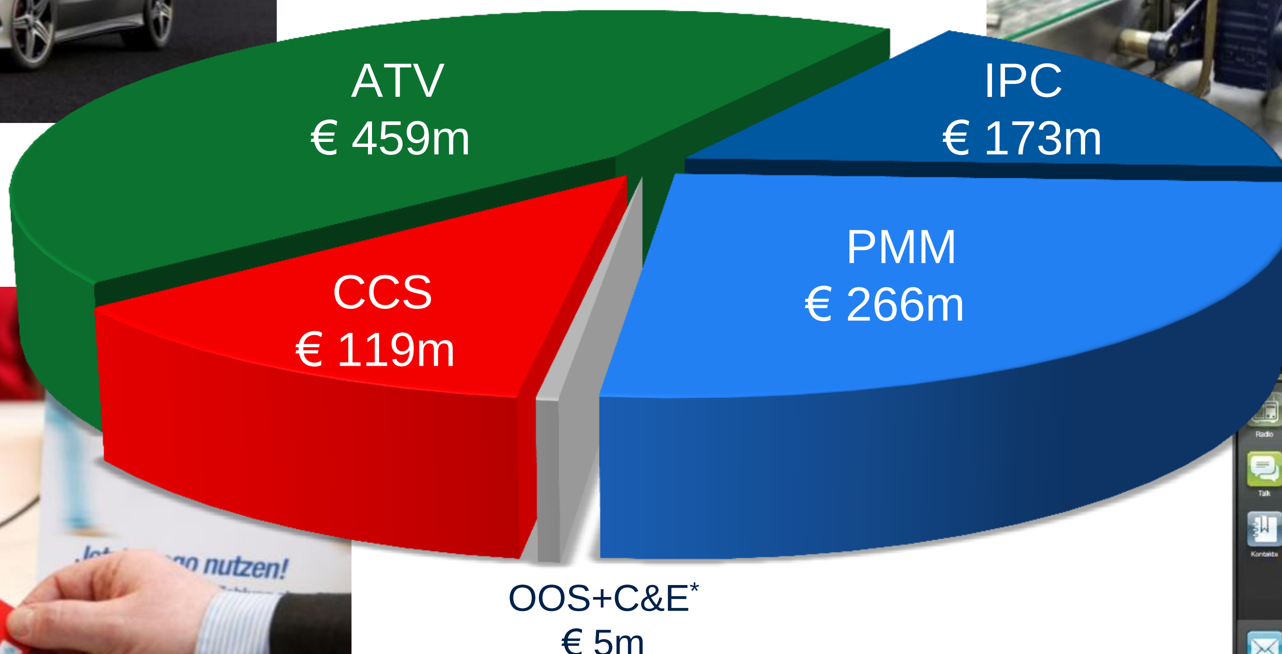
Revenue Split by Division

Q3 FY 2013 revenue: EUR 1,022m



* Other Operating Segments; Corporate and Eliminations.

Tight Customer Relationships are Based on System Know-how and App Understanding

Infineon

ATV

Autoliv
HELLA
BOSCH
Continental
DELPHI
DENSO
LEAR CORPORATION
HYUNDAI
TRW
Valeo

IPC

ABB
ALSTOM
BOMBARDIER
Danfoss
ENERCON ENERGY FOR THE WORLD
Rockwell Automation
Schneider Electric
SMA
SEMIKRON innovation+service
SIEMENS
YASKAWA

PMM

DELL
DELTA
EMERSON.
ERICSSON TAKING YOU FORWARD
[e] enphase ENERGY
hp
LG Life's Good
Microsoft
muRata
PHILIPS
Quanta Computer
OSRAM
power-one Changing the Shape of Power
SAMSUNG

CCS

hp
G+D
gemalto security to be free
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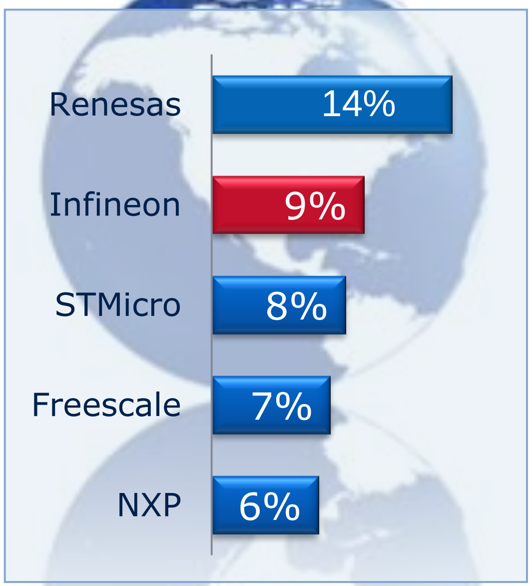
RUTRONIK ELECTRONICS WORLDWIDE

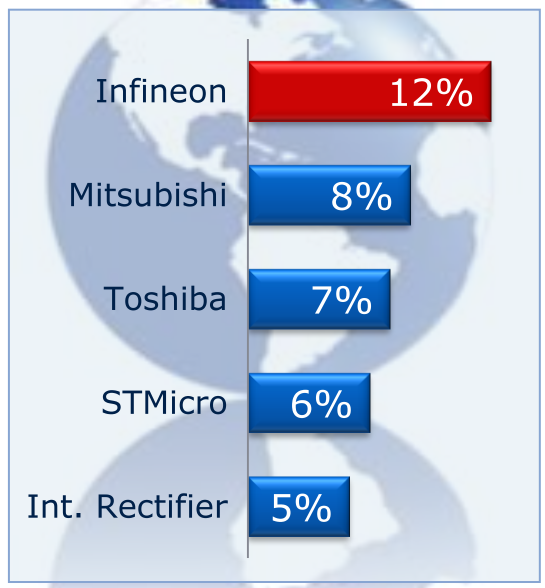
Infineon Holds Top Positions in All Target Markets

Automotive	Power	Chip Card
#2	#1	#1



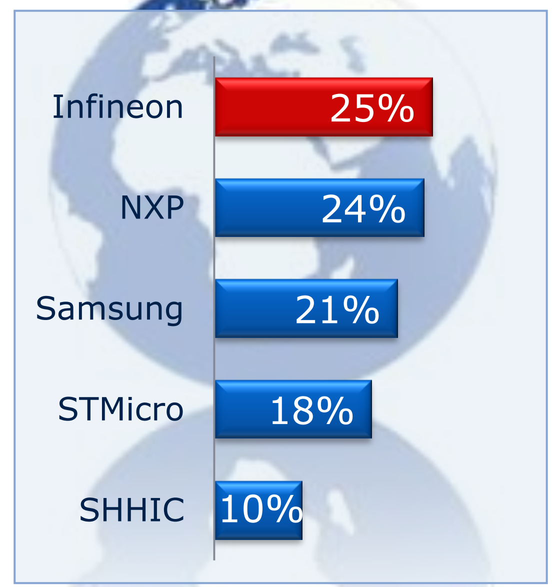
Calendar year 2012.

Source: Strategy Analytics, April 2013.



Calendar year 2011.

Source: IMS Research (an IHS company), July 2012.



Calendar year 2011.

Source: IMS Research (an IHS company), August 2012.

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Automotive Semiconductor Market 2012: Infineon #1 in Fastest-Growing Region APAC

World ($23.88bn)

1. Renesas	14.2%
2. Infineon	**9.1%**
3. STMicro	7.9%
4. Freescale	7.0%
5. NXP	6.3%
6. Bosch	5.7%
7. TI	5.7%

Europe ($8.04bn)

1. Infineon	**13.0%**
2. Bosch	11.3%
3. STMicro	10.0%
4. TI	8.4%
5. Renesas	7.8%
6. NXP	7.6%
7. Freescale	7.4%

APAC & others* ($5.70bn)

1. Infineon	**9.4%**
2. STMicro	9.4%
3. Renesas	9.0%
4. NXP	8.4%
5. Freescale	7.4%
6. TI	3.1%
7. Toshiba	3.0%

North America ($4.49bn)

1.Freescale	12.5%
2.Infineon	**8.4%**
3.Renesas	8.2%
4.STMicro	8.1%
5.TI	7.4%

Japan ($5.65bn)

1.Renesas	33.3%
2.Toshiba	13.0%
3.Fujitsu	4.5%
4.Sanken	3.9%
5.Infineon	**3.7%**

China ($2.82bn)

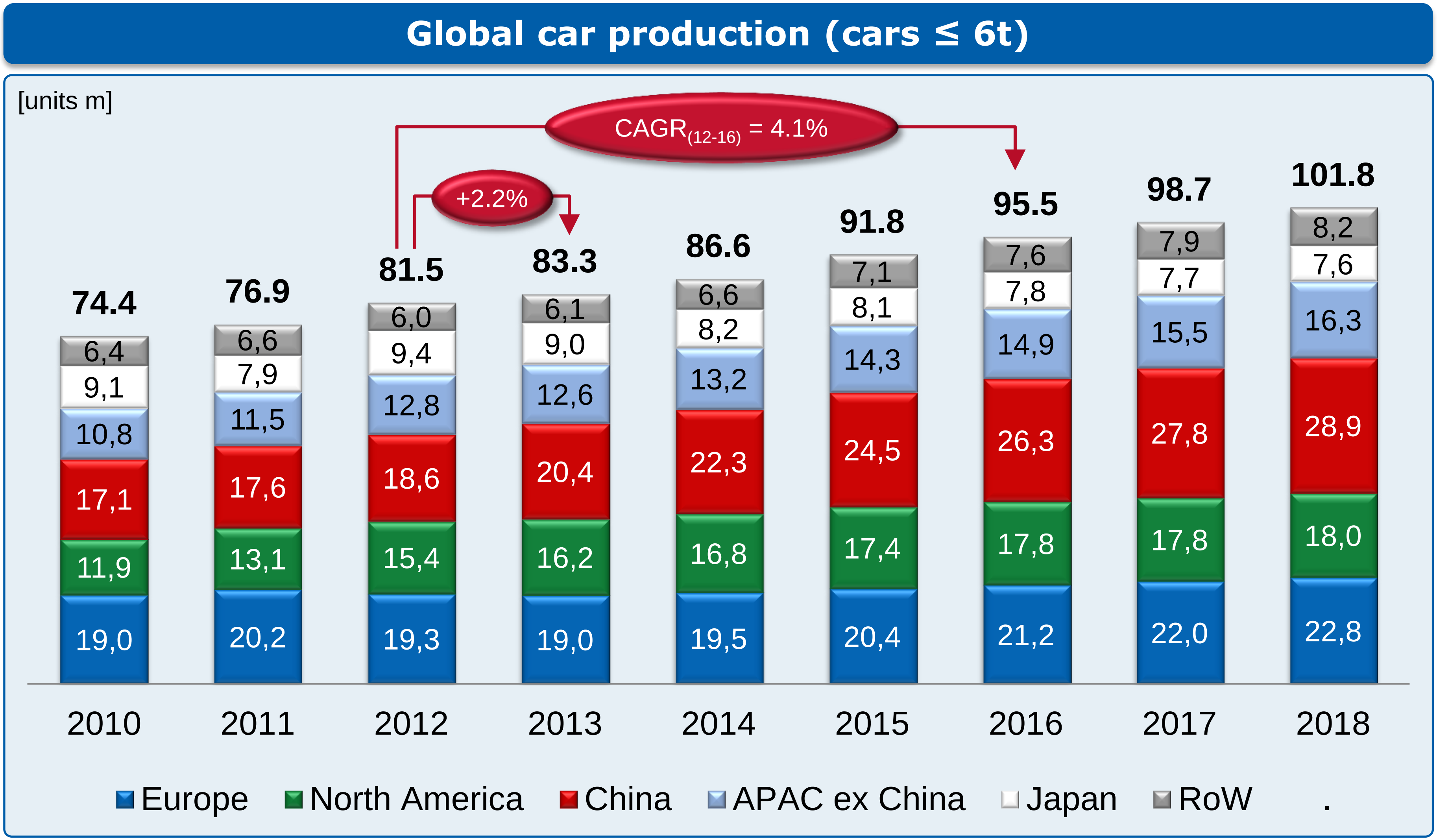
1.NXP	10.5%
2.STMicro	10.0%
3.Renesas	9.5%
4.Freescale	9.2%
5.Infineon	**7.0%**

Korea ($1.81bn)

1.Infineon	**13.7%**
2.STMicro	6.8%
3.Freescale	6.7%
4.NXP	5.6%
5.Bosch	3.9%

Source: Strategy Analytics, April 2013. * According to Strategy Analytics this ranking also includes Russia, India, South America and further countries.

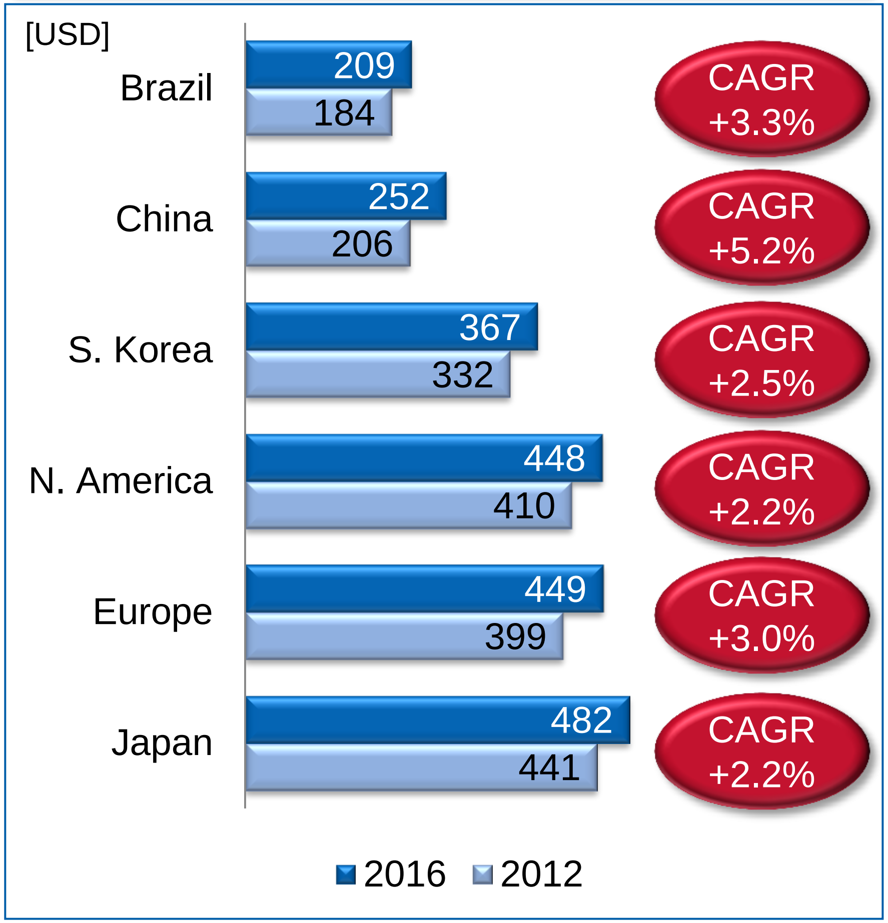
Despite Europe, Global Car Production Up in 2013; Long-Term Prospects Still Healthy



Source: IHS Inc., September 2013. www.ihs.com.

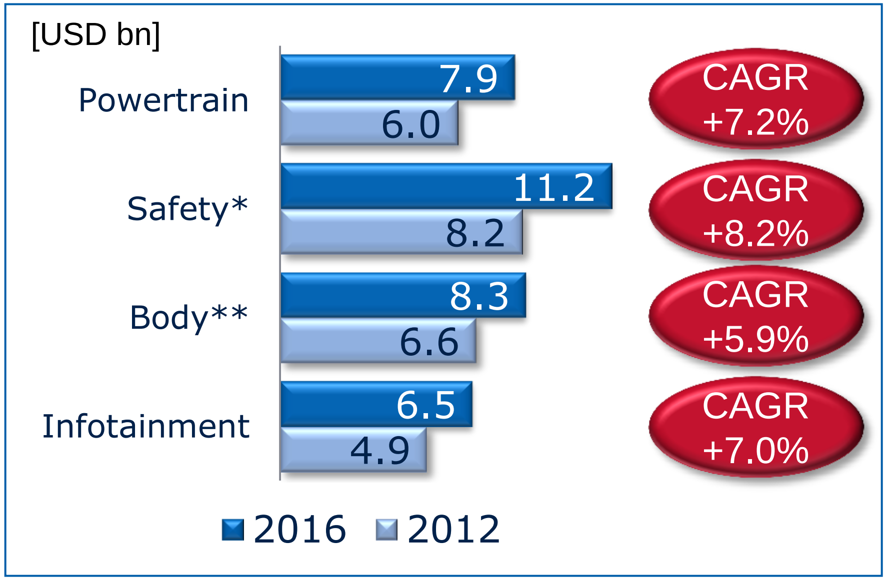
Semiconductor Value-Per-Car Continues to Increase

Semiconductor value per car by region



Semiconductor value per car

Semiconductor market by segment

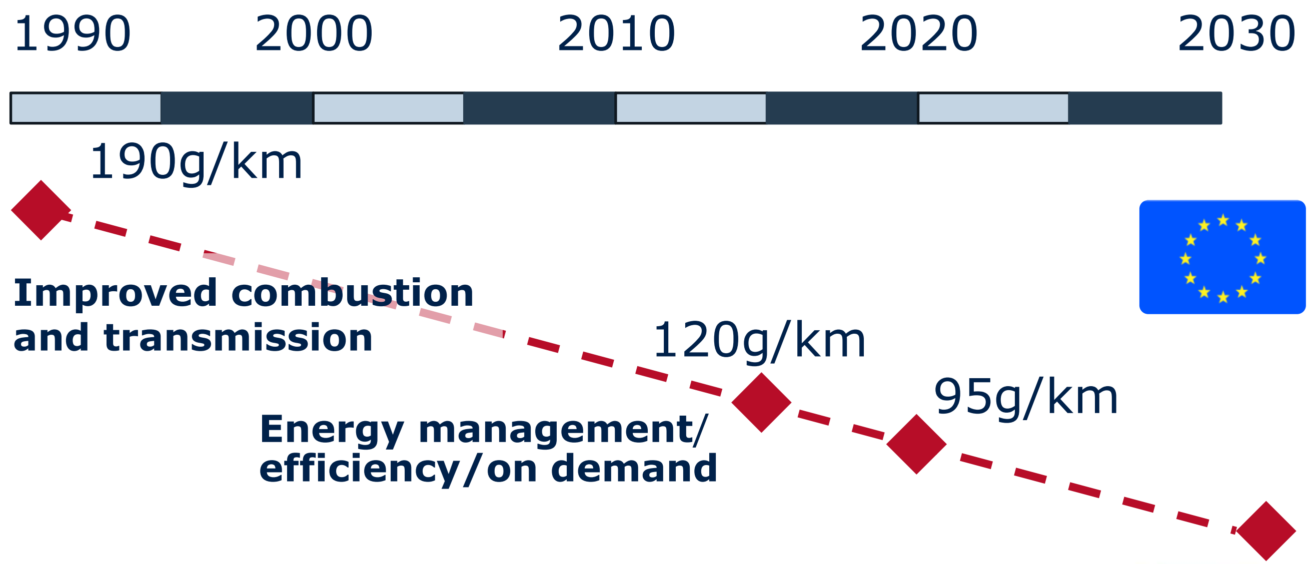


Source: Strategy Analytics (SA): “Automotive Semiconductor Demand Forecast 2011 – 2020”, July 2013; including semiconductor sensors.

* Safety = “Safety” + “Chassis” according to SA definition.
** Body = “Body” + “Security” according to SA definition.

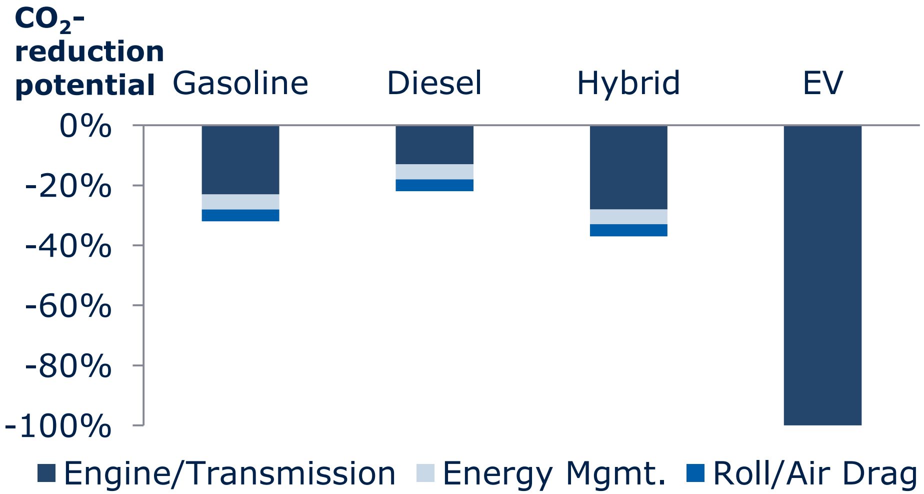
Expectations for Higher CO_2 Efficiency in Automotive are Extremely Demanding

CO_2 reduction roadmap for cars



Hybridization
Stop/start, Mild, Full Hybrid

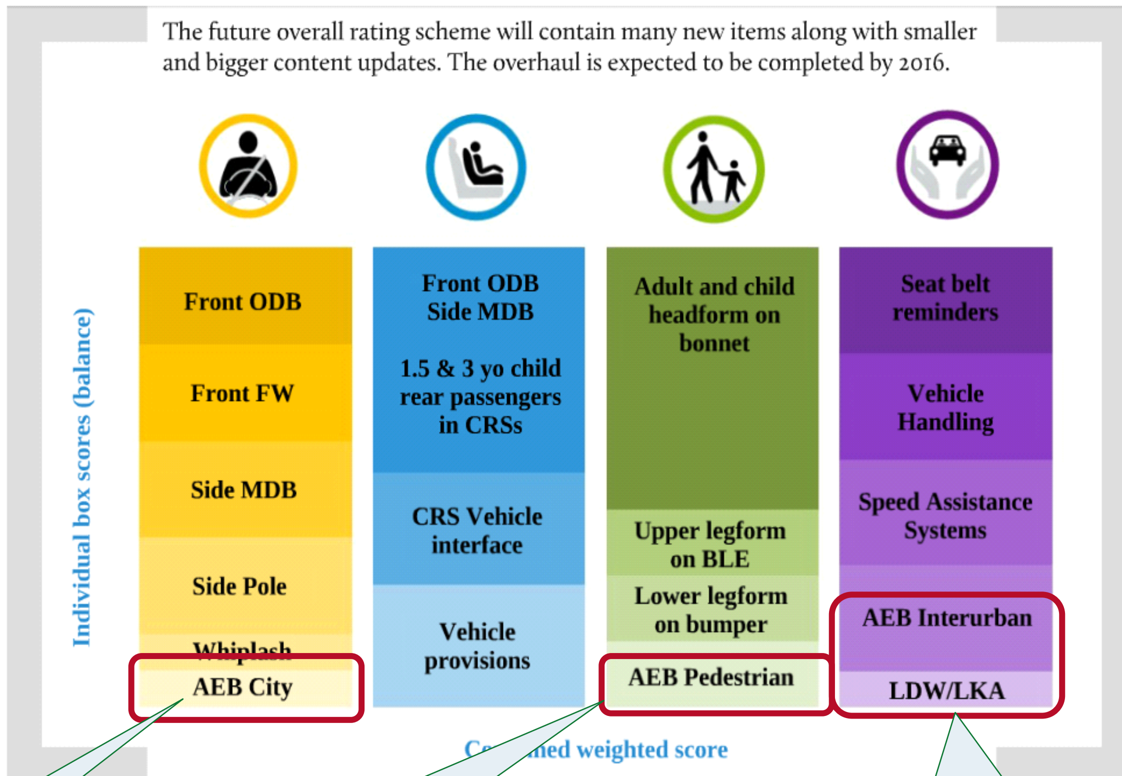
Improvement Areas



E-Mobility
Potential of "zero emission" using renewable energy.

Euro-NCAP 5-Star Rating Requires Radar and/or Camera Technology

- NCAP will drive ADAS.
- RADAR, camera are the key distance sensors enabling Advanced Emergency Braking (AEB).
- RADAR is the sensor of choice to cover critical conditions, e.g. rain, fog, night, bright sun-light.
- Camera is needed for lane assistance (LDW, LKA).



Starting 2014

Today: LIDAR, but range is too short to get all points.

Future: 2x range required.

Only RADAR or Camera enable all points.

Starting 2016

Today: LIDAR, but range is too short to get all points.

Only RADAR + Camera enable all points.

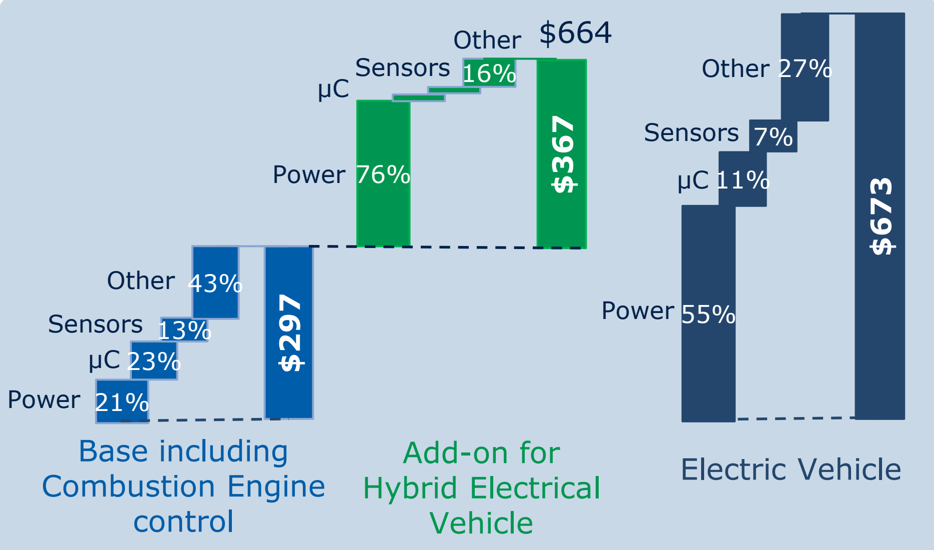
Starting 2014-2017

Long Range RADAR needed (>=70m).

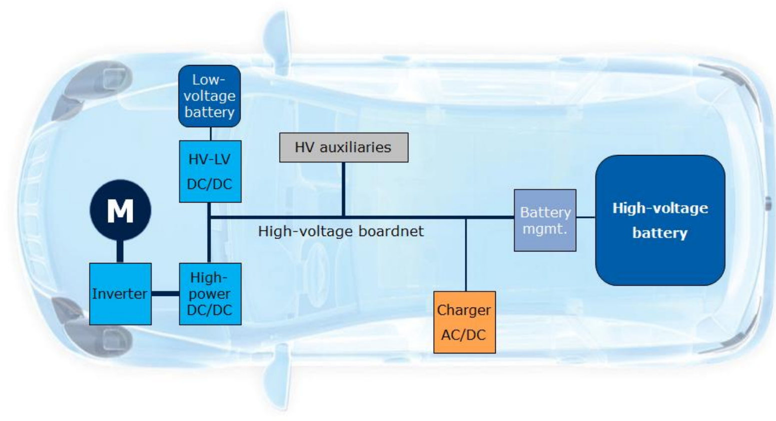
Camera needed for lane assist (LDW, LKA).

Semiconductors are the Major Enabler of Electric and Hybrid Vehicles

Average bill of material per car



Source: Strategy Analytics, April 2013, January 2012.

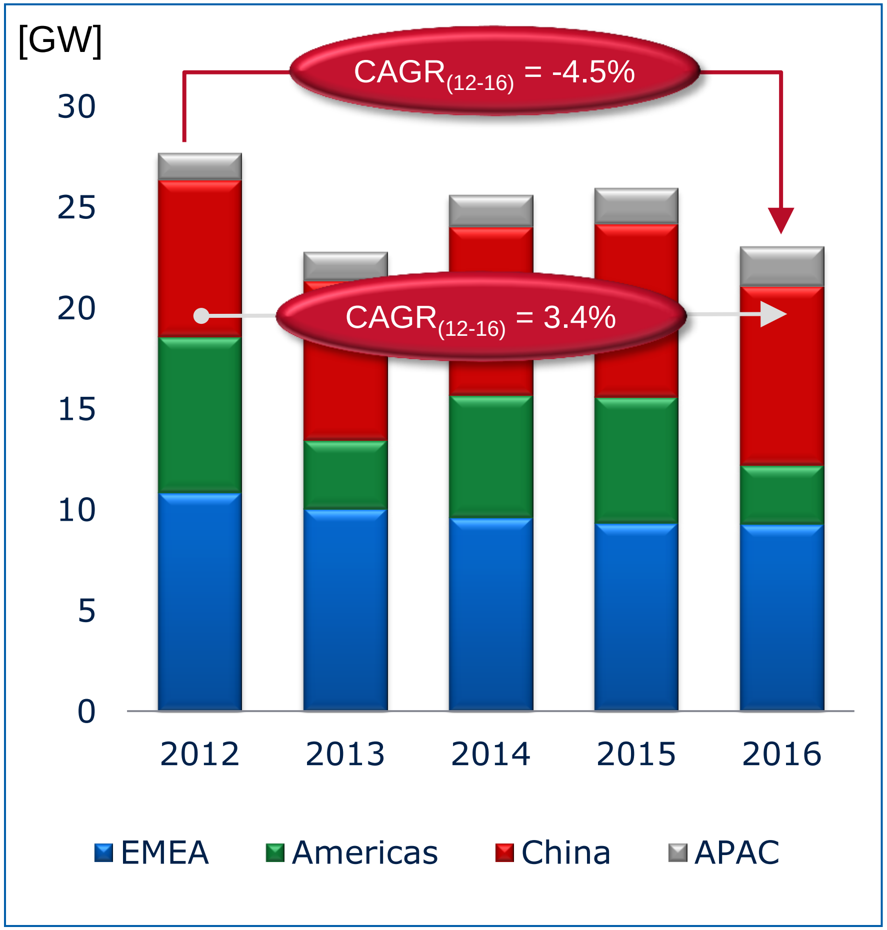


Schematics of electric drive drain system with auxiliaries

- Up to 80% of innovation in automotive is enabled by semiconductors, even more when it comes to Hybrid and EV
- Power Semiconductors are essential for the electrified powertrain and power conversion
- Efficiency of power semiconductor is a direct lever for range and lower system costs

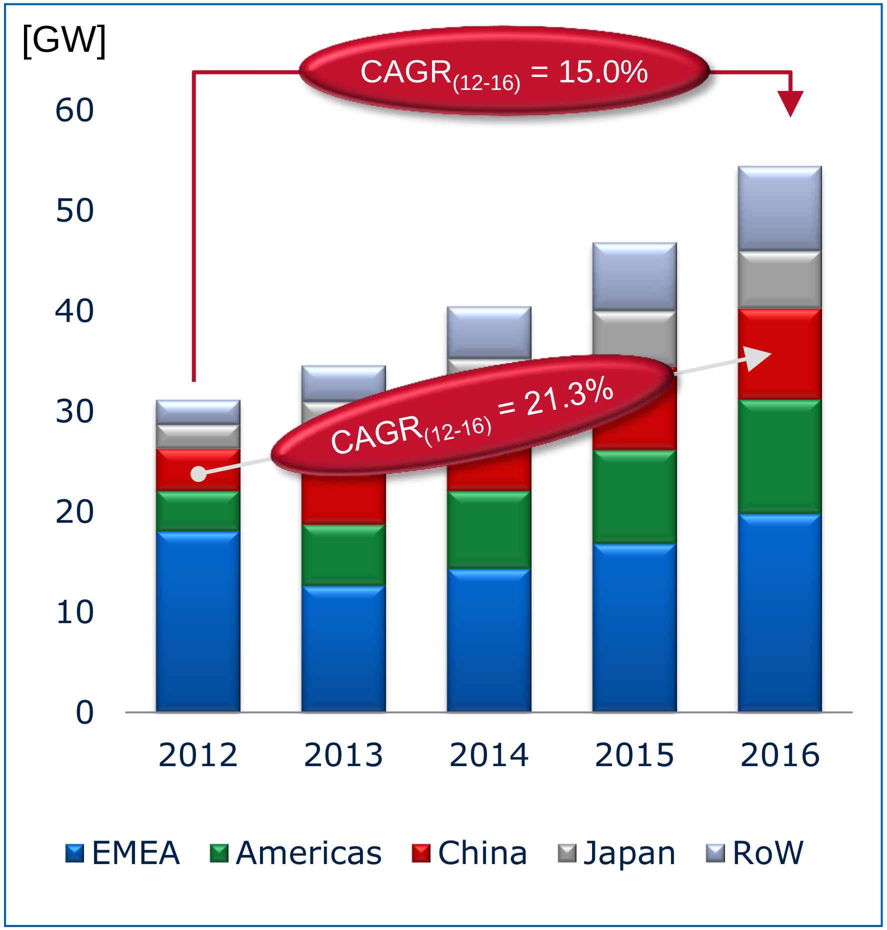
China is Driving the Market for Both Wind and Photovoltaic

Wind power installations



Source: IHS Inc. (IMS Research): “The World Market for Wind Converters – 2013 Edition”, July 2013.

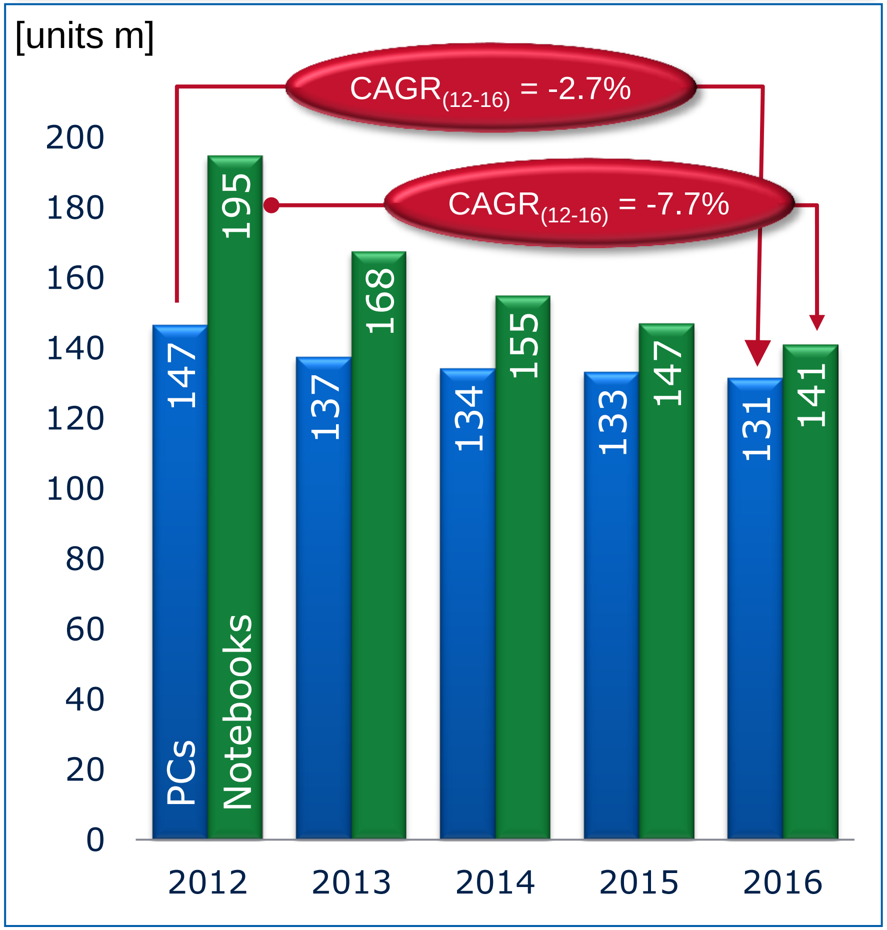
PV inverter installations by region



Source: IHS Inc. (IMS Research): “PV Inverter – World Market Report – 2013 Report”, July 2013.

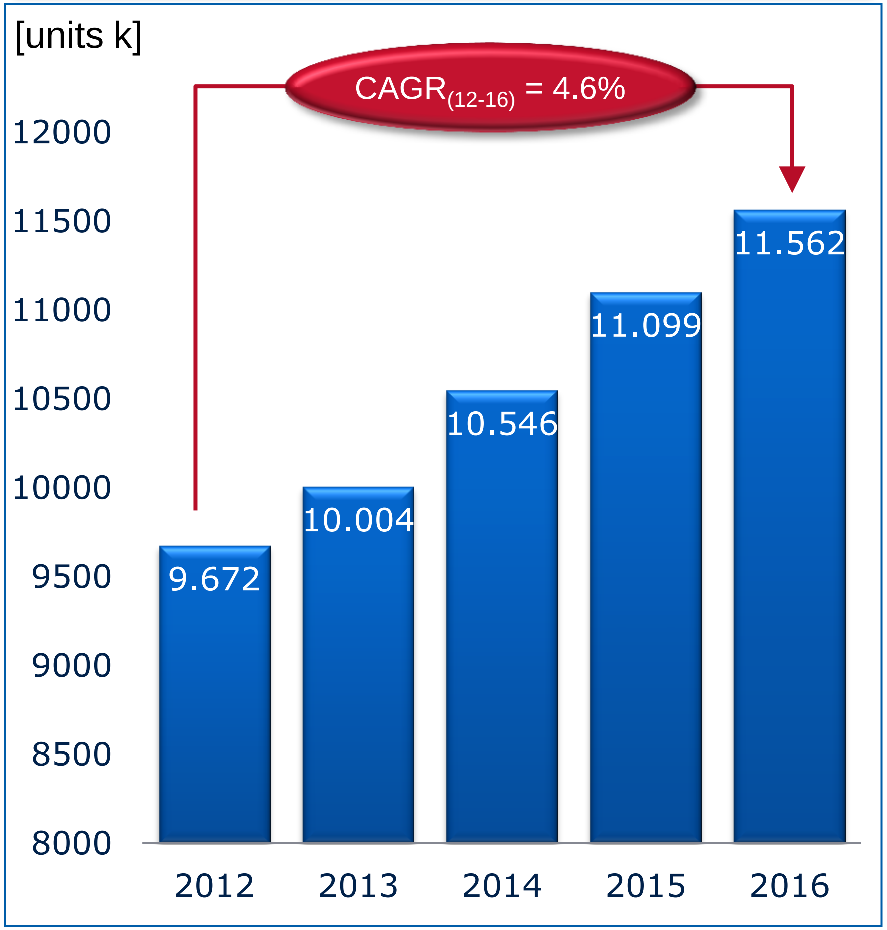
Growth in Servers Compensates Slowdown in PCs and Notebooks

PCs and Notebooks



Source: Gartner: “Desktop-Based PCs, Notebooks, Ultramobiles and Tablets, Worldwide: 2011 – 2017”, 2Q13 Update, July 2013.

Servers



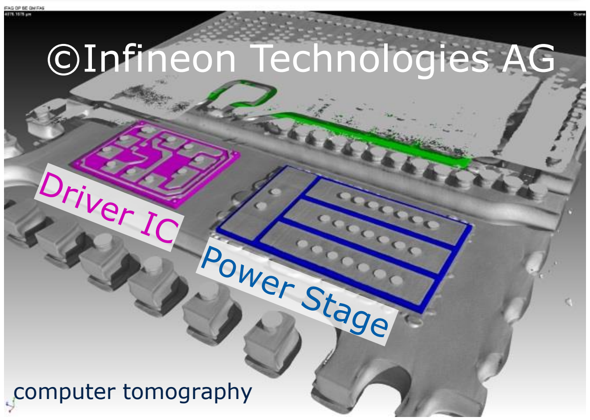
Source: Gartner: “Forecast: Servers, All Countries, 2011 – 2017”, 2Q13 Update, July 2013.

DrBlade: From Product to System

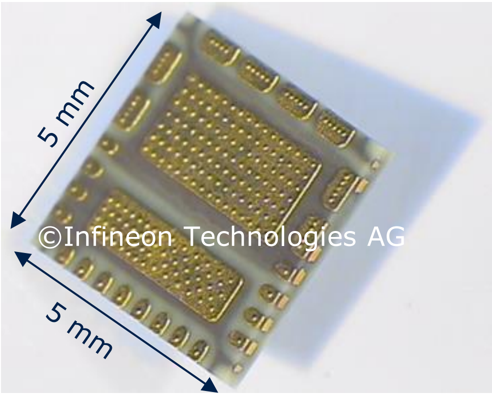
DrBlade: DC/DC for servers as System-in-Package solution

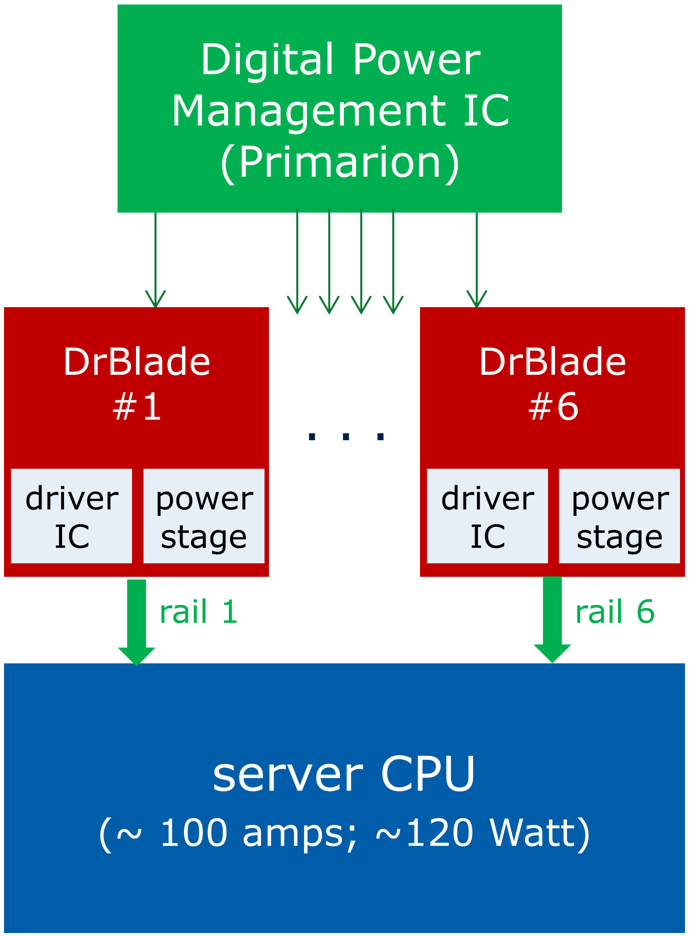
- Total solution: digital power management IC plus DrBlade.
- DrBlade: System-in-Package (SiP) of driver IC plus power stage (MOSFETs) using innovative chip-embedding packaging technology.

Top view



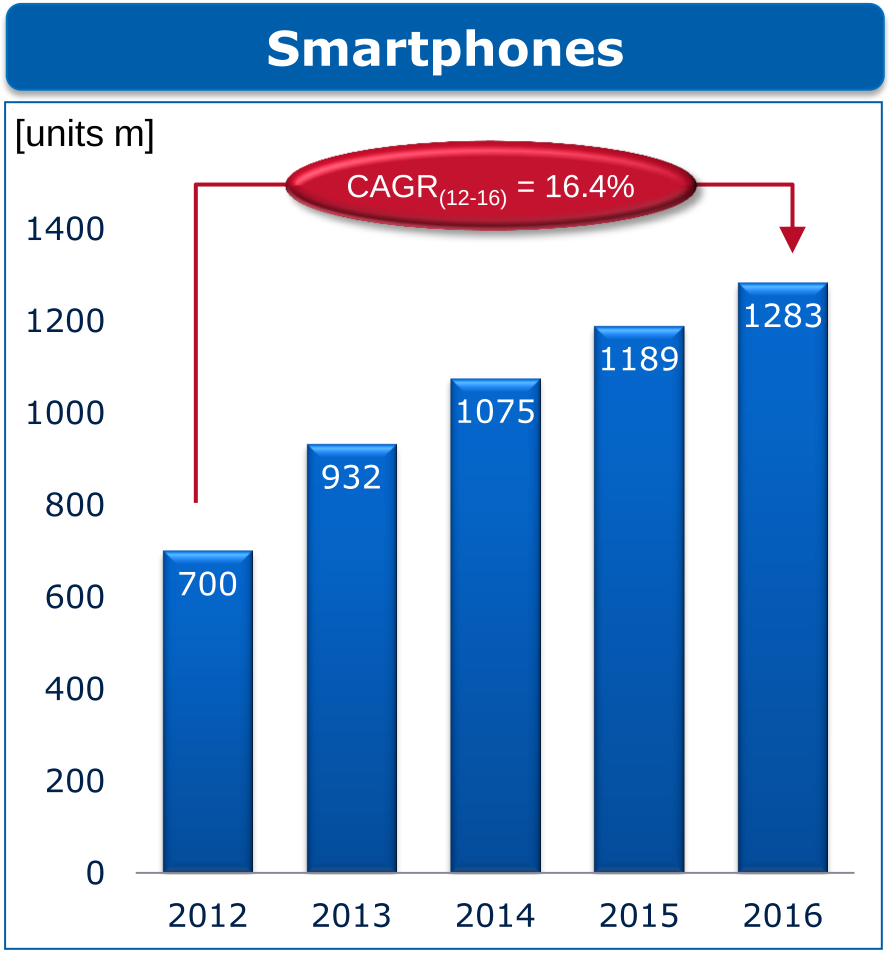
Bottom view

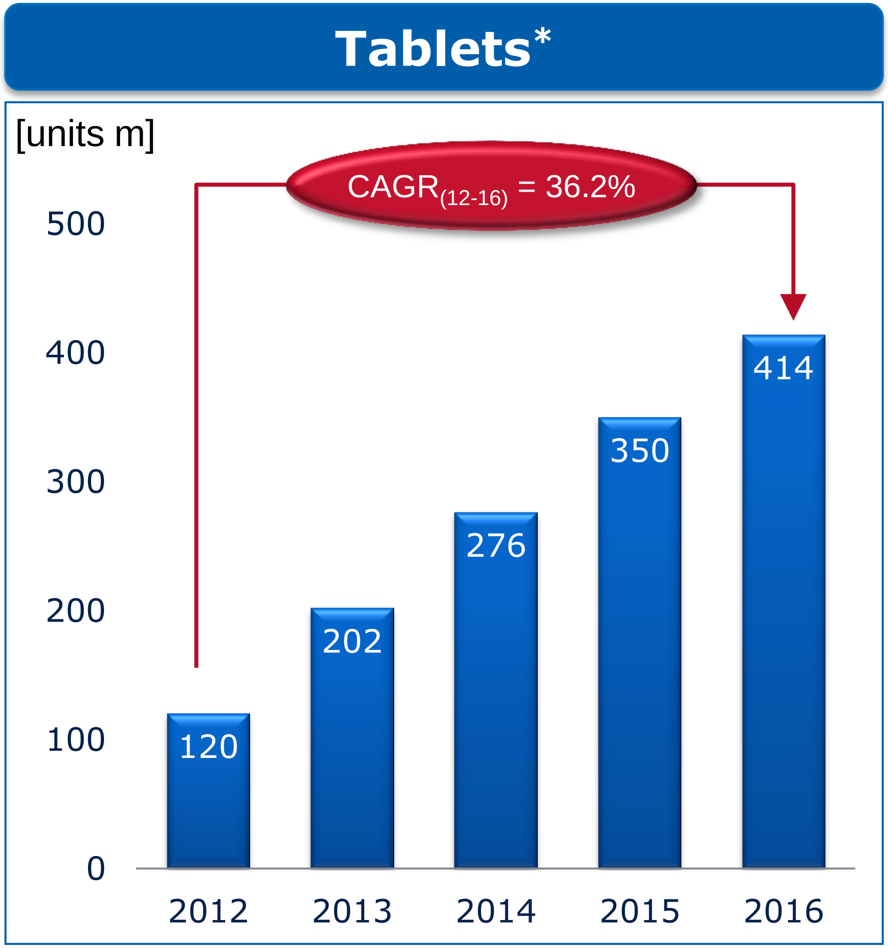




Our Business With RF Components, Si-Mics and Power Semis Fueled by Mobile Devices

Infineon





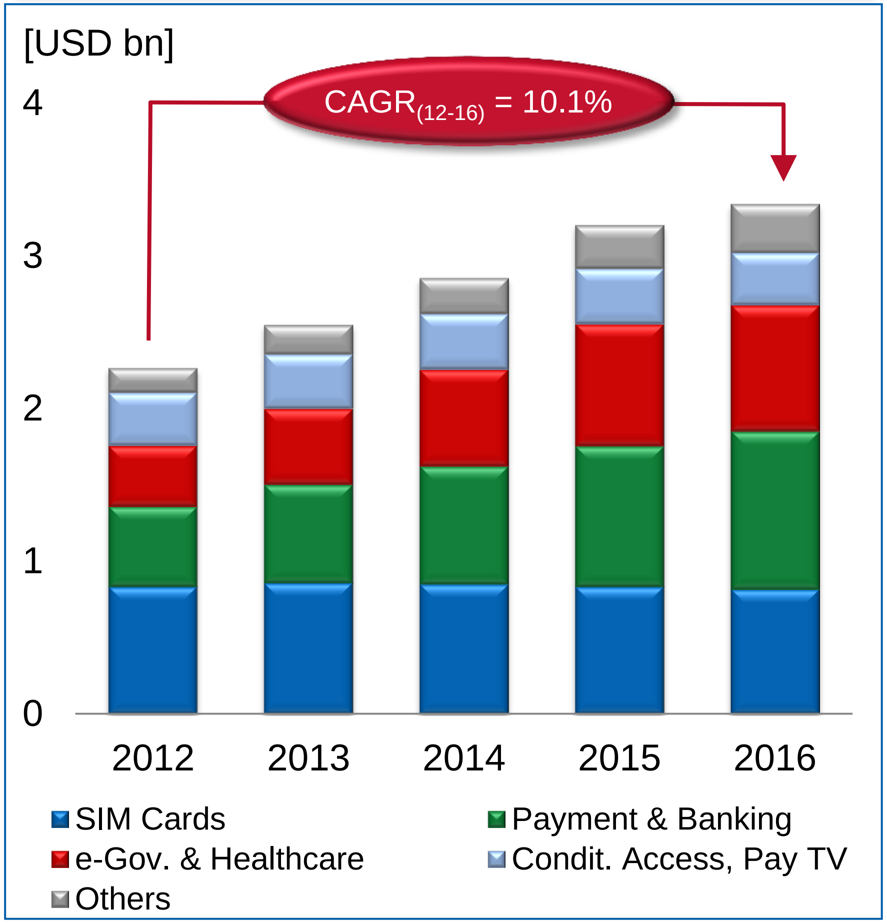
Source: Strategy Analytics: "Global Smartphone Sales Forecast for 88 Countries: 2007 to 2017", July 2013.

The chart was created by Infineon based on Gartner research.
Source: Gartner: "Forecast: Desk-based PCs, Notebooks, Ultramobiles, and Tablets, Worldwide, 2011 – 2017", 2Q13 Update, July 2013.

* Including Utility Tablets, Basic Tablets and Premium Tablets.

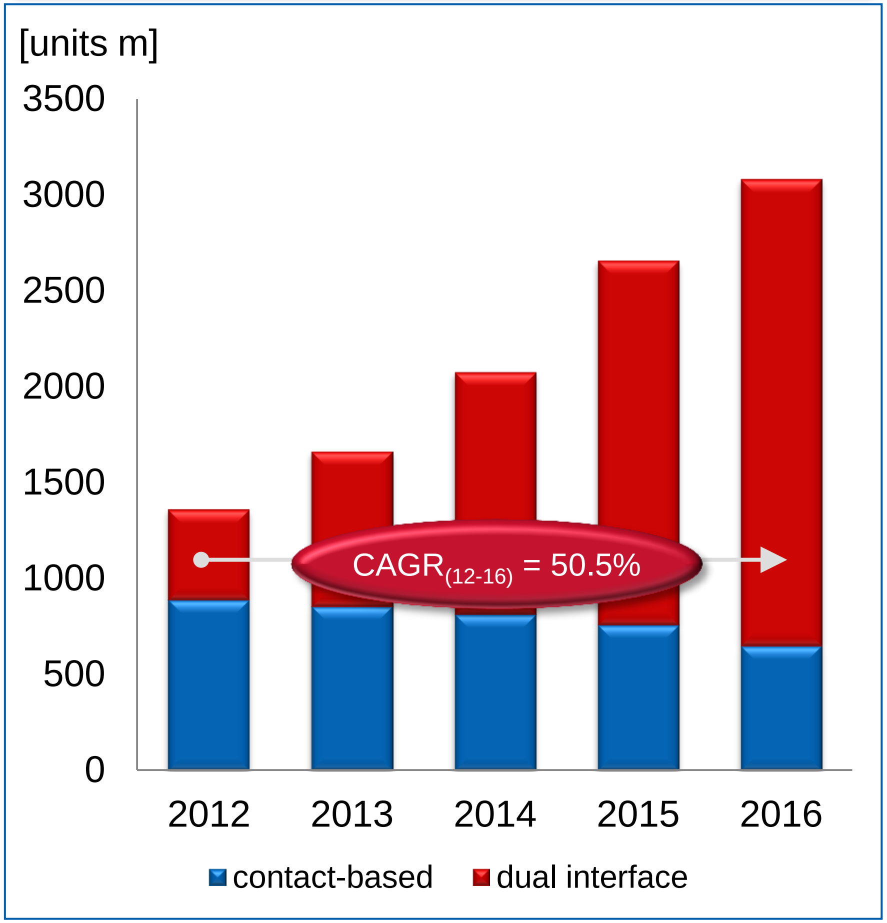
Double-digit Growth in Payment and Government ID; Boom at Dual Interface

Smart card ICs



Source: IMS Research (an IHS company): “Smart Card and IC Database – World – 1Q13 Update”, June 2013. Microcontroller only.

Payment and banking cards



Source: IMS Research (an IHS company): “The World Market for Payment and Banking Cards – World – 2013“, August 2013.

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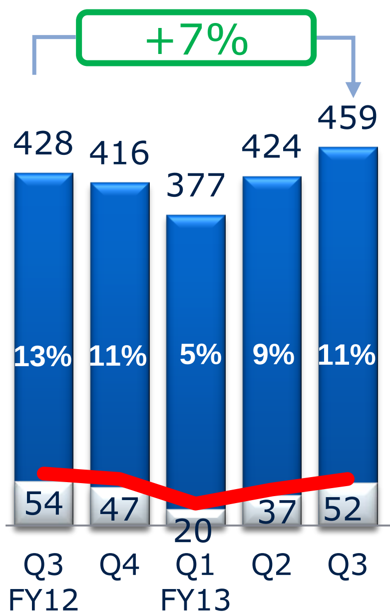
Record Sales in ATV; IPC Returned to More Normal Levels; Nice Margin Recovery in PMM


Courtesy: Daimler AG

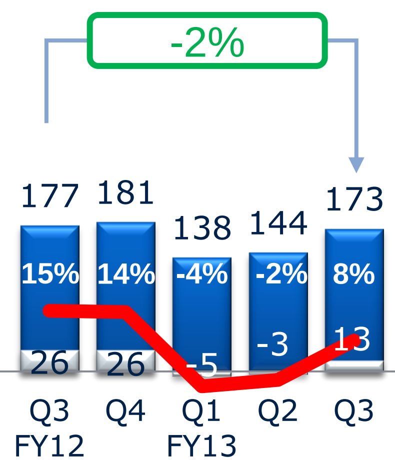
ATV

[EUR m]



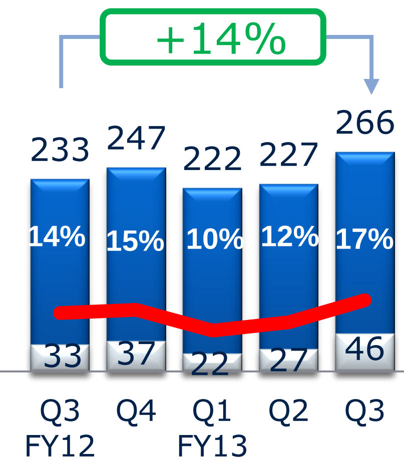
IPC

[EUR m]



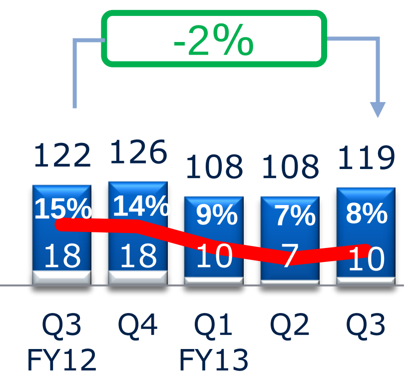
PMM

[EUR m]



CCS

[EUR m]



Revenue | Segment Result | Segment Result Margin

Guidance for Q4 FY13 and FY 2013

	Outlook Q4 FY13	Outlook FY 2013 (compared to FY 2012)
Revenue	About EUR 1,050m.	Decline of about 1.5%.
Segment Result Margin	About 13%.	Just under 10%.

Investments in FY 2013	Just under EUR 400m.
D&A in FY 2013	About EUR 470m.

Infineon is a Long-Standing Member of Europe's Leading Sustainability Indices

Dow Jones Sustainability Index

12 Sep 2014

MEMBER OF
Dow Jones
Sustainability Indices
In Collaboration with RobecoSAM

- Infineon is member of the Dow Jones Sustainability Index since 2010.
- Infineon performed very well in the fields of
  - Operational Eco-efficiency,
  - Product Stewardship, and
  - Innovation Management.

FTSE4Good Index

FTSE4Good

- Infineon was added to the FTSE4Good Index Series on 24 September 2001. It was confirmed by the FTSE4Good Policy Committee in its March 2013 review that Infineon continues to be a member of the FTSE4Good Index.

ENERGY EFFICIENCY
MOBILITY
SECURITY

Innovative semiconductor solutions for energy efficiency, mobility and security.

Financial Calendar

Date	Location	Event
12 Nov 2013*		Q4 FY13 and FY 2013 Results
18 – 19 Nov 2013	London	Company Roadshow including presentation by Andreas Urschitz Division President, Power Management & Multimarket
20 – 21 Nov 2013	Barcelona	Morgan Stanley TMT Conference
03 – 04 Dec 2013	Scottsdale, AZ	Credit Suisse Technology Conference

* provisional

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